

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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EPAS ID: PAT3052098

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JOHN J. PLOMBON	02/28/2006
ADRIEN R. LAVOIE	02/28/2006
JUAN E. DOMINGUEZ	02/28/2006
JOSEPH H. HAN	02/28/2006
HARSONO S. SIMKA	02/28/2006
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	INTEL CORPORATION
<b>Street Address:</b>	2200 MISSION COLLEGE BOULEVARD
<b>City:</b>	SANTA CLARA
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95054
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	11365082
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(612)677-3572
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	6123142740
<b>Email:</b>	sgabrysiak@cpaglobal.com
<b>Correspondent Name:</b>	SCOTT GABRYSIK
<b>Address Line 1:</b>	PO BOX 52050
<b>Address Line 2:</b>	C/O CPA GLOBAL
<b>Address Line 4:</b>	MINNEAPOLIS, MINNESOTA 95054
<b>NAME OF SUBMITTER:</b>	LEE WOLFE
<b>SIGNATURE:</b>	/Lee Wolfe/
<b>DATE SIGNED:</b>	10/03/2014
<b>Total Attachments: 3</b>	
source=P23254 Assignment#page1.tif	
source=P23254 Assignment#page2.tif	



## ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

**John J. Plombon; Adrien R. Lavoie; Juan E. Dominguez;  
Joseph H. Han; Harsono S. Simka**

hereby sell, assign, and transfer to:

### **Intel Corporation**

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95052 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions and improvements that are disclosed in the application for the United States patent entitled:

### **CATALYTICALLY ENHANCED ATOMIC LAYER DEPOSITION PROCESS**

(I hereby authorize and request my attorney, associated with Customer Number 08791, to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on \_\_\_\_\_ as

United States Application Number \_\_\_\_\_ and

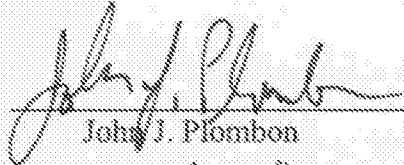
which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said inventions and improvements; and in and to all rights of priority resulting from the filing of said United States applications;

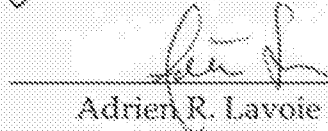
agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof, and generally assist said Assignee, its

successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

  
\_\_\_\_\_  
John J. Plombon

2-28-2006  
(Today's Date)

  
\_\_\_\_\_  
Adrien R. Lavoie

2/28/2006  
(Today's Date)

  
\_\_\_\_\_  
Juan E. Dominguez

2/28/06  
(Today's Date)

\_\_\_\_\_  
Joseph H. Han

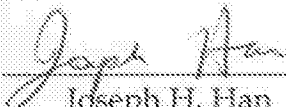

\_\_\_\_\_  
(Today's Date)

\_\_\_\_\_  
Harsono S. Simka

\_\_\_\_\_  
(Today's Date)

successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

_____ John J. Plombon	_____ (Today's Date)
_____ Adrien R. Lavoie	_____ (Today's Date)
_____ Juan E. Dominguez	_____ (Today's Date)
 _____ Joseph H. Han	02/27/06 _____ (Today's Date)
 _____ Harsono S. Simka	02/28/06 _____ (Today's Date)